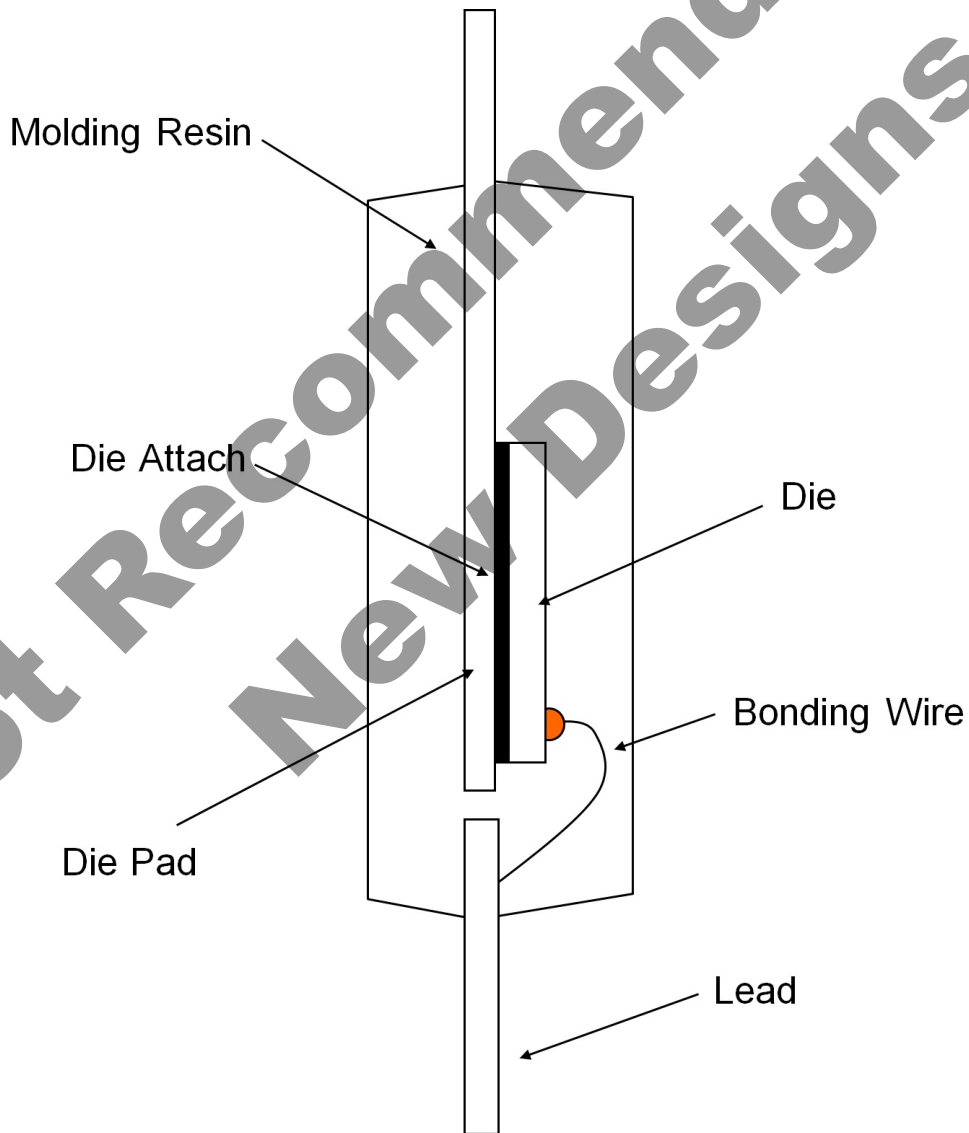


## 1. Package Information

Package Name	HSIP10
Type	SIP
Pin Count	10
Outline Dimension	B0819
Drawing No.	
Package Weight [g]	2.93
Lead Finish	Pure Tin
MSL Level	Level1

## 2. Package Structure



## 3. Packing Specification

## 3.1 Packing form, Quantity

Packing Form		Tube
Packing Quantity	[pcs]	20

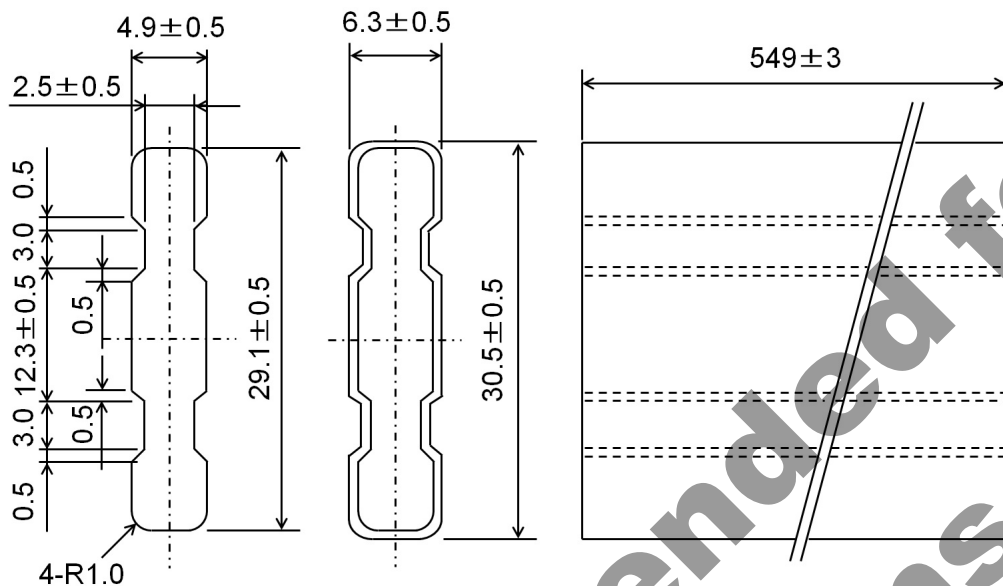
## 3.2 Use material

Item	Material
Tube	PVC
Stopper	PVC
Unit box	Cardboard
Shipping box	Cardboard

Not Recommended for  
New Designs

3.3 Tube Specification

3.3.1 Tube Dimension

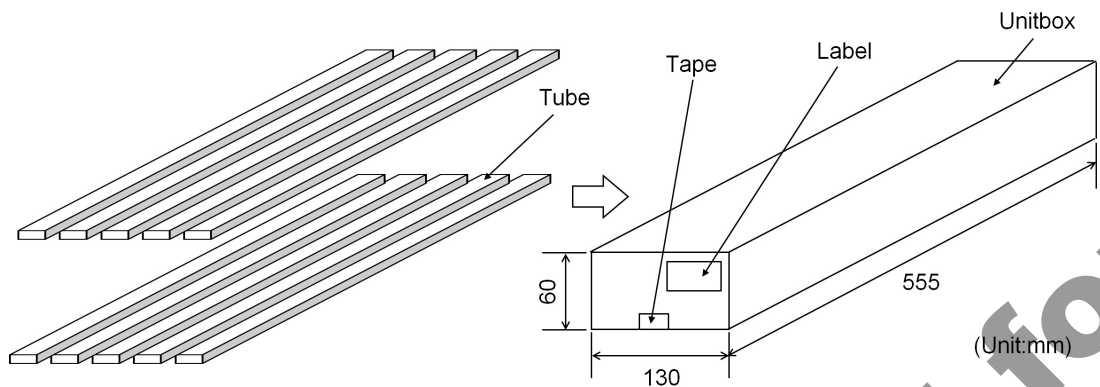


(unit:mm)

Not Recommended for New Designs

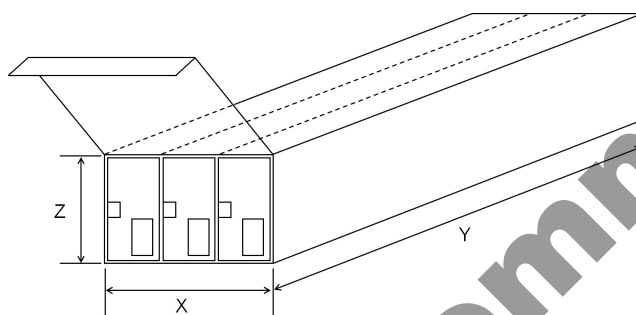
3.4 Packing Method

25 tube(s) or less per unit box



3.9 Packing Style

3 unit boxes or less per shipping box



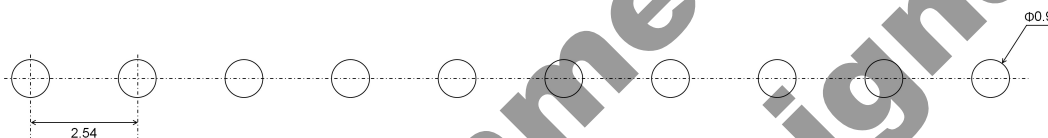
(unit:mm)

Shipping Box Dimension	
X	230
Y	579
Z	136

3.10 Label Specification



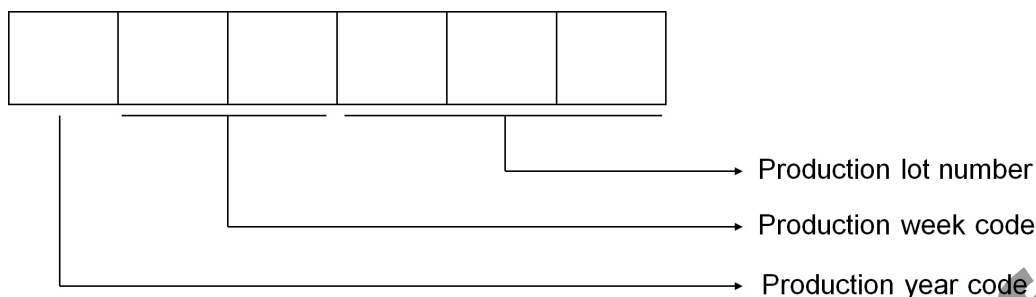
4. Footprint dimensions



(unit:mm)

In actual design, please optimize in accordance with the situation of your board design and soldering condition.

5. Marking Specification



6. Storage conditions

6.1 Storage environment

Recommended storage conditions

	Min.	Max.	Unit
Temperature	5	30	°C
Humidity	40	70	% RH

6.2 Storage period

	Min.	Max.	Unit
Storage period	-	1	year

7. Soldering conditions

7.1 Recommended condition for wave soldering

Preheating temperature	:	120 °C to 150 °C
Preheating time	:	60 sec MAX
Soldering temperature	:	260 °C ± 3 °C
Soldering time	:	12 sec MAX

Notes for wave soldering

- (1) Soldering time is provided for total soldering time in case of dual wave soldering.
- (2) Do not use other soldering methods with wave soldering.
- (3) Recommend to clean the board to eliminate flux, solder waste, and other impurities for reliability, after soldering.
- (4) Optimize soldering condition to prevent solder bridging.

7.2 Recommended condition for solder iron

Solder iron temperature	:	380 °C or less
Mounting time	:	4 sec or less

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